

Inventor: Rickie C. Lake
Title: An Epoxy, Epoxy System, and Method of Forming a Conductive
Adhesive Connection
Assignee: Micron Technology, Inc.
Attorney File No. MI40-327



INFORMATION DISCLOSURE STATEMENT

PURSUANT TO 37 C.F.R. §§ 1.56, 1.97 AND 1.98

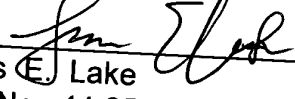
In compliance with 37 C.F.R. §§ 1.56, 1.97 and 1.98, your attention is directed to the United States patents and other references listed on the attached Form PTO-1449. No admission is made regarding whether all the submitted references are prior art.

The listed references were cited by, or submitted to, the Office in the parent, co-pending application of the above-identified application. The above-identified application is a continuation application of co-pending application Serial No. 09/392,073, filed September 8, 1999. Such prior disclosure is sufficient for the above-identified application as far as copies of the references are concerned. 37 C.F.R. § 1.98(d) and MPEP § 609(2).

Citation of these references is respectfully requested.

Respectfully submitted,

Dated: 26 Apr 2001

By: 
James E. Lake
Reg. No. 44,854

EL 465782735

Form PTO-1449

U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICEATTY. DOCKET NO.
MI40-327SERIAL NO.
Priority 09392,073LIST OF ART CITED BY APPLICANT
(Use several sheets if necessary)APPLICANT
Rickie C. LakeFILING DATE
Priority September 8, 1999GROUP
Priority 1751

U.S. PATENT DOCUMENTS

*Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate
	AA	5,649,296	7/15/97	MacLellan et al.	455	38.2	6/19/95
	AB	5,621,412	4/15/97	Sharpe et al.	342	51	6/7/95
	AC	4,926,182	5/15/90	Ohta et al.	342	44	5/29/87
	AD	4,075,632	2/21/78	Baldwin et al.	343	6.8	5/24/76
	AE	4,587,038	6/6/86	Tamura			
	AF	4,469,714	9/4/84	Wada et al.			
	AG	4,780,371	10/25/88	Joseph et al.			
	AH	4,324,713	4/13/82	Kita et al.			
	AI	4,210,704	7/1/80	Chandross et al.			
	AJ	5,021,473	6/4/91	Macholdt et al.			
	AK	4,661,562	4/28/87	Goel			
	AL	5,431,795	7/11/95	Morelant et al			
	AM	5,068,062	11/26/91	Inata et al			

FOREIGN PATENT DOCUMENTS

		Document Number	Date	Country	Class	Subclass	Translation	
							Yes	No
	AN							
	AO							
	AP							
	AQ							
	AR							

OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, Etc.)

	AS		
	AT		

EXAMINER

DATE CONSIDERED

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

 11002 U.S. PTO
 09/04/01
